#### **SCOPE:**

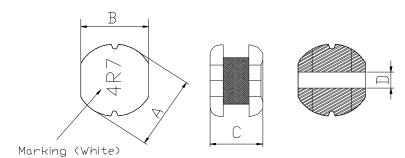
This specification applies to the Pb Free high current type SMD inductors for MSCD-0315-SERIES

#### PRODUCT INDENTIFICATION

MSCD - 0315 - 4R7 M

- (1)
- 2
- 3 4
- 1 Product Code
- 2 Dimensions Code
- **3 Inductance Code**
- **4** Tolerance Code

## (1) SHAPES AND DIMENSIONS



A: 3.5±0.3 mm
B: 3.0±0.3 mm
C: 1.5±0.3 mm
D: 1.2 Typ. mm

# (2) ELECTRICAL SPECIFICATIONS SEE TABLE 1

**TEST INSTRUMENTS** 

L : HP 4284A PRECISION LCR METER (or equivalent)

RDC: CHROMA MODEL 16502 MILLIOHMMETER (or equivalent)

## (3) CHARACTERISTICS

(3)-1 Ambient temperature ......  $+60^{\circ}$ C Max.

(3)-2 Operate temperature range ......  $-40^{\circ}$ C  $\sim +125^{\circ}$ C (Including self temp. rise)

(3)-3 Storage temperature range ......  $-40^{\circ}\text{C} \sim +125^{\circ}\text{C}$ 



TABLE 1

MAGLAYERS	Inductance	Percent	Test	Resistance	Rated DC Current		Marking	
PT/NO.	L(µH)	Tolerance	Frequency	RDC(Ω)Max.	IDC1(A)	IDC2(A)	- Marking	
MSCD-0315-1R0□	1.0	M,N	100kHz/0.25V	62m	1.60	2.05	1R0	
MSCD-0315-2R2	2.2	M,N	100kHz/0.25V	0.13	1.20	1.50	2R2	
MSCD-0315-3R3	3.3	M,N	100kHz/0.25V	0.14	0.90	1.30	3R3	
MSCD-0315-4R7□	4.7	M,N	100kHz/0.25V	0.18	0.65	1.05	4R7	
MSCD-0315-5R6□	5.6	M,N	100kHz/0.25V	0.26	0.60	1.00	5R6	
MSCD-0315-6R8	6.8	M,N	100kHz/0.25V	0.27	0.55	0.90	6R8	
MSCD-0315-8R2	8.2	M,N	100kHz/0.25V	0.36	0.50	0.81	8R2	
MSCD-0315-100	10	M,N	100kHz/0.25V	0.39	0.45	0.70	100	
MSCD-0315-120□	12	M,N	100kHz/0.25V	0.45	0.42	0.65	120	
MSCD-0315-150□	15	M,N	100kHz/0.25V	0.75	0.30	0.63	150	
MSCD-0315-180□	18	M,N	100kHz/0.25V	0.76	0.29	0.60	180	
MSCD-0315-220□	22	M,N	100kHz/0.25V	0.92	0.25	0.57	220	
MSCD-0315-270□	27	M,N	100kHz/0.25V	1.12	0.23	0.50	270	
MSCD-0315-330□	33	M,N	100kHz/0.25V	1.43	0.20	0.45	330	
MSCD-0315-470□	47	M,N	100kHz/0.25V	1.69	0.17	0.35	470	
MSCD-0315-560□	56	M,N	100kHz/0.25V	1.92	0.15	0.32	560	
MSCD-0315-680□	68	M,N	100kHz/0.25V	2.86	0.13	0.28	680	
MSCD-0315-820□	82	M,N	100kHz/0.25V	3.25	0.128	0.27	820	
MSCD-0315-101□	100	K,M	100kHz/0.25V	4.55	0.125	0.26	101	
MSCD-0315-121	120	K,M	100kHz/0.25V	4.55	0.123	0.25	121	
MSCD-0315-181	180	K,M	100kHz/0.25V	7.15	0.122	0.22	181	
MSCD-0315-221	220	K,M	100kHz/0.25V	8.32	0.120	0.20	221	
MSCD-0315-271	270	K,M	100kHz/0.25V	12.61	0.115	0.18	271	
MSCD-0315-331	330	K,M	100kHz/0.25V	14.56	0.10	0.16	331	
MSCD-0315-391□	390	K,M	100kHz/0.25V	16.12	0.09	0.12	391	
MSCD-0315-471□	470	K,M	100kHz/0.25V	18.20	0.09	0.10	471	

 $<sup>\</sup>times$   $\square$  specify the inductance tolerance, K(±10%), M(±20%), N(±30%)

※ IDC1: Based on inductance change (△L/Lo: drop 10% Max.) @ambient temperature 25℃

IDC2: Based on temperature rise (△T: 40°C TYP.)
Rated DC Current: The less value which is IDC1 or IDC2.



# (4) RELIABILITY TEST METHOD MECHANICAL

TEST ITEM	SPECIFICATION	TEST DETAILS			
Substrate bending	∆L/Lo≦±5%	The sample shall be soldered onto the printed circuit board			
		in figure 1 and a load applied unitil the figure in the arrow			
	There shall be	direction is made approximately 3mm.(keep time 30 seconds)			
	no mechanical	PCB dimension shall the page 7/9			
	damage or elec-	F(Pressurization)			
	trical damege.	Л			
		R5 45±2 45±2 10 20 10 R340			
		PRESSURE ROD figure-1			
Vibration	∆L/Lo≦±5%	The sample shall be soldered onto the printed circuit board			
		and when a vibration having an amplitude of 1.52mm			
	There shall be	and a frequency of from 10 to 55Hz/1 minute repeated should			
	no mechanical	be applied to the 3 directions (X,Y,Z) for 2 hours each.			
	damage.	(A total of 6 hours)			
Solderability	New solder	Flux (rosin, isopropyl alcohol{JIS-K-1522}) shall be coated			
Solderability	More than 90%	over the whole of the sample before hard, the sample shall			
		then be preheated for about 2 minutes in a temperature of			
		130~150°C and after it has been immersed to a depth 0.5mm			
		below for 3±0.2 seconds fully in molten solder M705 with			
		a temperature of 245±5°C.			
		More than 90% of the electrode sections shall be couered			
		with new solder smoothly when the sample is taken out of			
		the solder bath.			

#### **MECHANICAL**

TEST ITEM	SPECIFICATION					
TEST ITEM Resistance to Soldering heat reflow soldering)	There shall be no damage or problems.	Temperature profile of reflow soldering  300  250  Reak temperature 200:30 10 sec  150  Pre-heating  Slow cooling (Stored at room temperature)  2 min 100  2 min or mere  The specimen shall be passed through the reflow oven with the condition shown in the above profile for 1 time.  The specimen shall be stored at standard atmospheric conditions for 1 hour, after which the measurement shall be made.				

### **ELECTRICAL**

TEST ITEM	SPECIFICATION	TEST DETAILS		
Insulation	There shall be	DC 100V voltage shall be applied across this sample of top		
resistance	no other	surface and the terminal.		
	damage or	The insulation resistance shall be more than $1 \times 10^8 \Omega$ .		
	problems.			
Dielectric	There shall be	AC 100V voltage shall be applied for 1 minute acrosset the top		
withstand	no other	surface and the terminal of this sample		
voltage	damage or			
	problems.			
Temperature	∆L/L20°C ≦±10%	The test shall be performed after the sample has stabilized in		
characteristics	0~2000 ppm/℃	an ambient temperature of -20 to +85 $^{\circ}\!$		
		calculated based on the value applicable in a normal		
		temperature and narmal humidity shall be △L/L20°C ≦±10%.		



### **ENVIROMENT CHARACTERISTICS**

TEST ITEM		SPECIFICATION						
High temperature	∆L/Lo≦±5%	The sample shall be left for 96±4 hours in an atmospere with						
storage		a tempera	a temperature of 85±2℃ and a normal humidity.					
	There shall be	Upon con	Upon completion of the measurement shall be made after the					
	no mechanical	sample ha	sample has been left in a normal temperature and normal					
	damage.	humidity	humidity for 1 hour.					
Low temperature	∆L/Lo≦±5%	The samp	The sample shall be left for 96±4 hours in an atmosphere with					
storage		a tempera	a temperature of -25±3℃.					
	There shall be	Upon con	Upon completion of the test, the measurement shall be made					
	no mechanical	after the s	samp	ole has been left in a no	rmal temperature and			
	damage. normal humidity for 1 hour.							
Change of	∆L/Lo≦±5%	The samp	The sample shall be subject to 5 continuos cycles, such as shown					
temperature		in the tab	in the table 2 below and then it shall be subjected to standard					
	There shall be	atmosphe	atmospheric conditions for 1 hour, after which measurement					
	no other dama-	shall be n	shall be made.					
	ge of problems							
			table 2					
				Temperature	Duration			
			1	<b>−25±3°</b> C	30 min.			
				(Themostat No.1)				
			2	Standard	No.1→No.2			
				atmospheric				
			3	<b>85±2</b> ℃	30 min.			
				(Themostat No.2)				
			4	Standard	No.2→No.1			
				atmospheric				
Moisture storage	∆L/Lo≦±5%	The sample shall be left for 96±4 hours in a temperature of						
		40±2°C and a humidity(RH) of 90∼95%.						
	There shall be	Upon completion of the test, the measurement shall be made after the sample has been left in a normal temperature and						
	no mechanical							
	damage.		normal humidity more than 1 hour.					
Test conditions :		I		<u>-</u>				
	sample shall be reflo	w soldered o	onto	the printed circuit boar	d in every test.			



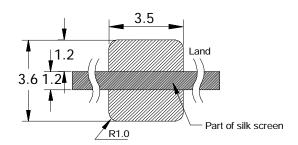
# (5) LAND DIMENSION (Ref.)

PCB: GLASS EPOXY t=1.6mm

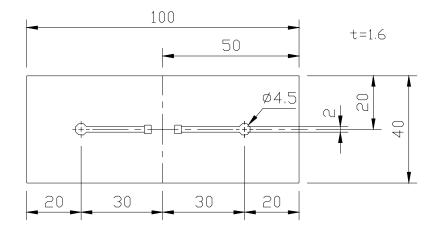
### (5)-1 LAND PATTERN DIMENSIONS

(STANDARD PATTERN)

Unit:mm

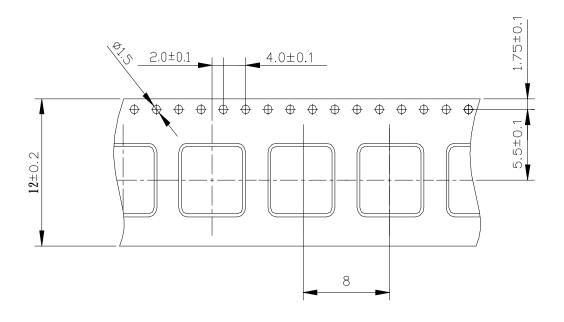


## (5)-2 SUBSTRATE BENDING TEST BENDING TEST BOARD

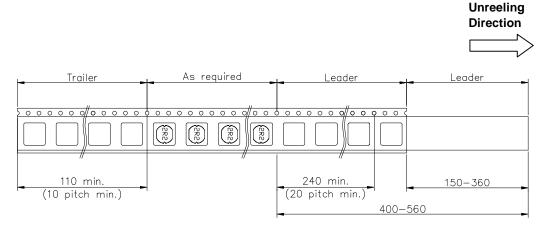


# (6) PACKAGING

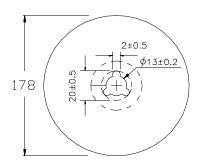
# (6)-1 CARRIER TAPE DIMENSIONS (mm)

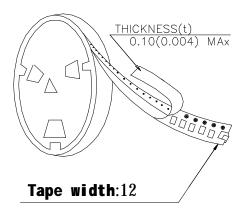


## (6)-2 TAPING DIMENSIONS (mm)



## (6)-3 REEL DIMENSIONS (mm)





## (6)-4 QUANTITY

1000pcs/Reel

The products are packaged so that no damage will be sustained.